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DISPLAY ELEMENT, ITS MANUFACTURING
METHOD AND DISPLAY DEVICE**(30) **Foreign Application Priority Data**

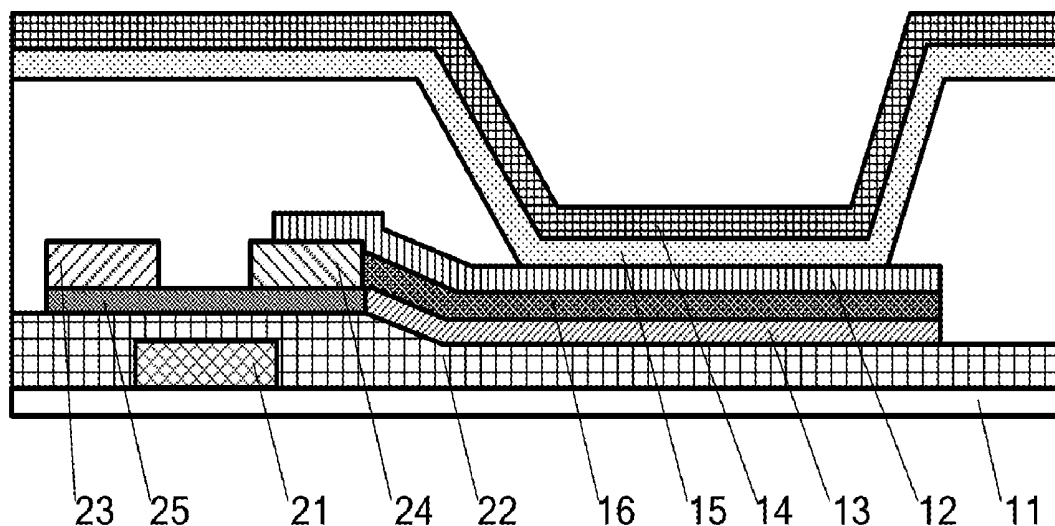
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(CN)(57) **ABSTRACT**

An OLED display element, its manufacturing method and a display device are provided. The OLED display element includes a light-emitting pixel unit. The light-emitting unit includes an anode arranged above a base substrate, a cathode arranged opposite to the anode, and a micro cavity formed between the anode and the cathode. The micro cavity includes an organic light-emitting layer, and the anode includes an ITO layer arranged opposite to the cathode and a metal oxide conductor layer arranged at a side of the ITO layer that is farther away from the cathode than the other side of the ITO layer.

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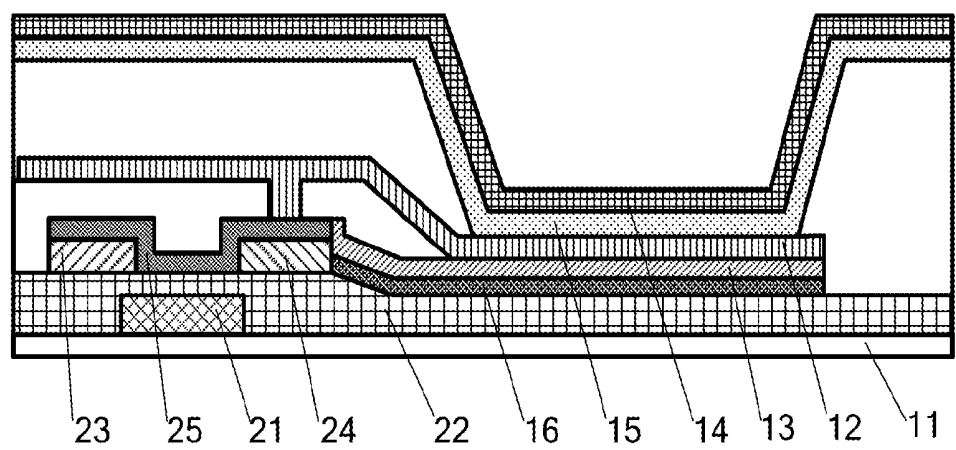


FIG. 1

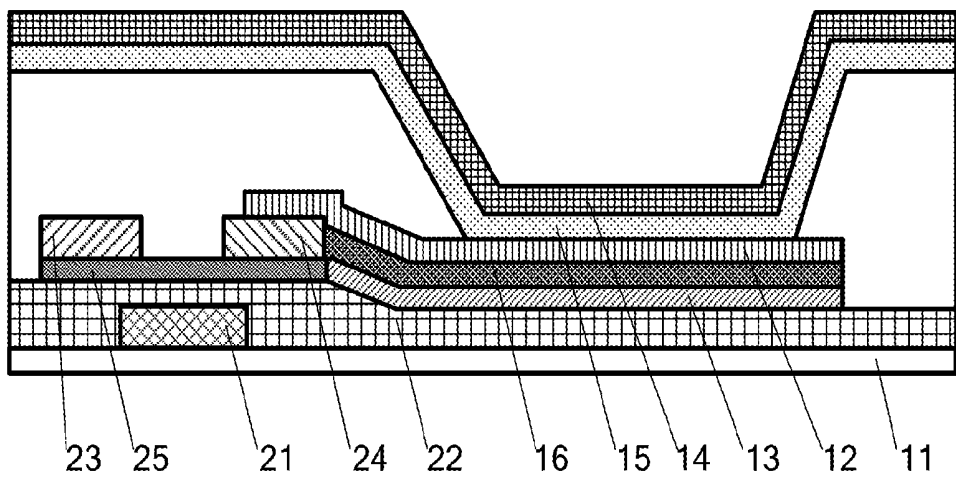


FIG. 2

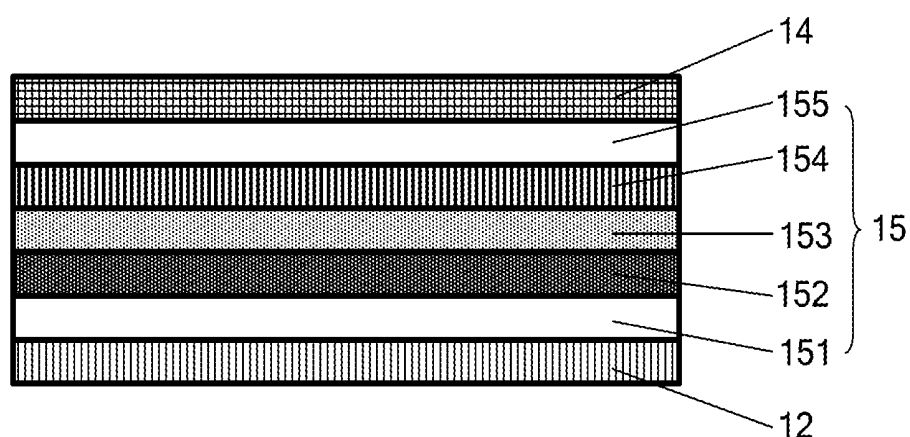


FIG. 3

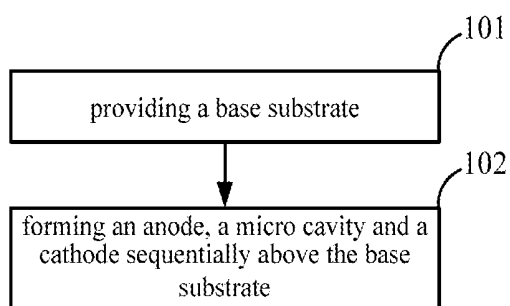


FIG. 4

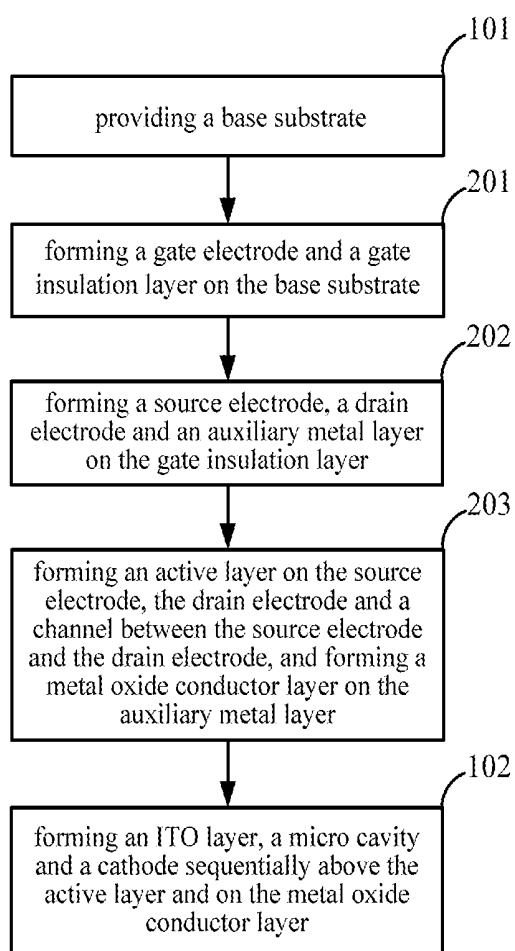


FIG. 5

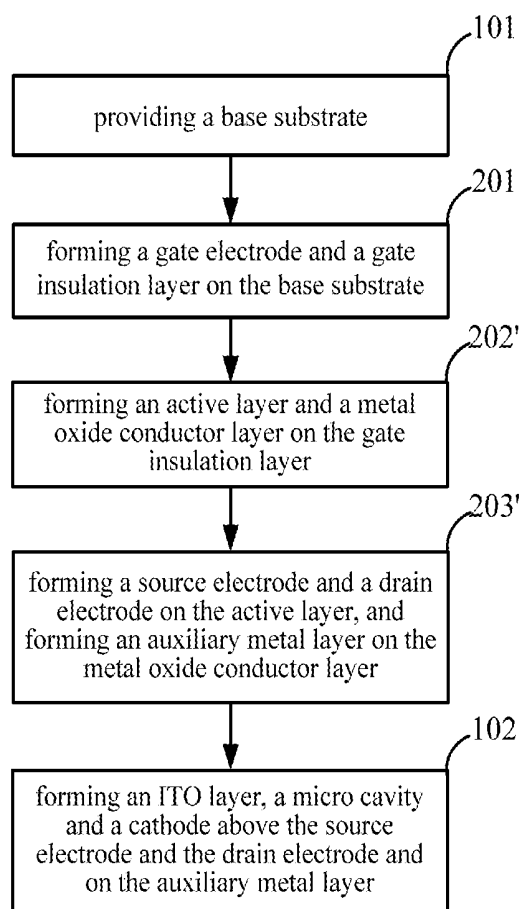


FIG. 6

ORGANIC LIGHT-EMITTING DIODE DISPLAY ELEMENT, ITS MANUFACTURING METHOD AND DISPLAY DEVICE

CROSS-REFERENCE TO RELATED APPLICATION

[0001] The present application claims a priority of the Chinese patent application No. 201510297822.5 filed on Jun. 1, 2015, which is incorporated herein by reference in its entirety.

TECHNICAL FIELD

[0002] The present disclosure relates to the field of display technology, in particular to an organic light-emitting diode (OLED) display element, its manufacturing method and a display device.

BACKGROUND

[0003] OLED display element has attracted more and more attentions due to advantages such as self-luminescence, being rich-colored, rapid response, wide viewing angle, small weight and thickness, low power consumption, and being capable of achieving flexible display. In addition, a display device with the OLED display elements has a broad application prospect.

[0004] The OLED display element has a basic, sandwich-like structure consisting of an anode, a cathode and an organic light-emitting layer between the anode and the cathode. Usually, the anode is thin and transparent, and is an indium tin oxide (ITO) layer having a semiconductor characteristic, and the cathode is a metal layer or a metal oxide layer. In the case that a voltage is applied to the OLED display element, electron holes from the anode may be combined with electrons from the cathode at the light emitting layer, so as to enable the OLED display element to emit light through the anode or cathode. However, due to the limit of its structure, the luminous intensity and the luminous efficiency of the OLED display element are relatively low.

SUMMARY

[0005] An object of the present disclosure is to provide an OLED display element, so as to improve the luminous intensity and the luminous efficiency of the OLED display element.

[0006] In one aspect, the present disclosure provides in some embodiments an OLED display element, including a light-emitting pixel unit. The light-emitting pixel unit includes an anode arranged above a base substrate, a cathode arranged opposite to the anode, and a micro cavity formed between the anode and the cathode. The micro cavity includes an organic light-emitting layer, and the anode includes an ITO layer arranged opposite to the cathode and a metal oxide conductor layer arranged at a side of the ITO layer that is farther away from the cathode than the other side of the ITO layer.

[0007] According to the OLED display element in the embodiments of the present disclosure, the anode of the light-emitting pixel unit includes the ITO layer and the metal oxide conductor layer. In the case that a voltage is applied to the OLED display element, holes in the ITO layer and the metal oxide conductor layer and electrons in the cathode are transported to the organic light-emitting layer. The holes and the electrons meet in the organic light-emitting layer, so as

to excite the organic light-emitting layer to generate photons in various energy states, thereby to generate light beams. The photons in various energy states are reallocated in the micro cavity between the anode and the cathode, so that the light beam transmitted from the organic light emitting layer and having a wavelength in conformity with a resonant cavity mode may be transmitted to an exterior of the OLED display element, thereby the OLED display element starts to emit light. As compared with the prior art where merely the ITO layer is used as the anode of the light-emitting pixel unit, in the embodiments of the present disclosure, the ITO layer and the metal oxide conductor layer are used as the anode of the light-emitting pixel unit. A cavity length of the micro cavity may be adjusted, so as to improve a micro cavity effect of the OLED display element. In addition, due to the fact that the anode is formed by the ITO layer and the metal oxide conductor layer, it is able to improve a work function of the anode and increase the luminous intensity of a light beam having a specific wavelength, thereby to improve the luminous intensity and the luminous efficiency of the OLED display element. Further, due to the micro cavity between the cathode and the anode made by the ITO layer and the metal oxide conductor layer, it is able to narrow a full width at half maximum (FWHM) of the light beam from the OLED display element, i.e., to acquire a narrowed spectrum, and prevent the light beams in different colors from interfering with each other, thereby to improve color purity of the OLED display element.

[0008] In another aspect, the present disclosure provides in some embodiments a display device including the above-mentioned OLED display element, so as to improve the luminous intensity and the luminous efficiency of the OLED display element.

[0009] The advantages of the display device are identical to those of the above-mentioned OLED display element, and thus will not be particularly defined herein.

[0010] In yet another aspect, the present disclosure provides in some embodiments a method for manufacturing the above-mentioned OLED display element, so as to improve the luminous intensity and the luminous efficiency of the OLED display element. The method includes steps of providing a base substrate, and forming an anode, a micro cavity and a cathode sequentially above the base substrate. The micro cavity includes an organic light-emitting layer, and the anode includes a metal oxide conductor layer and an ITO layer adjacent to the micro cavity.

[0011] The advantages of the method are identical to those of the above-mentioned OLED display element, and thus will not be particularly defined herein.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] The drawings herein are incorporated into, and constitute a part of, the specification. The embodiments of the present disclosure are for illustrative purposes only, but shall not be used to limit the scope of the present disclosure. In the drawings,

[0013] FIG. 1 is a schematic view showing an OLED display element according to one embodiment of the present disclosure;

[0014] FIG. 2 is a schematic view showing another OLED display device according to one embodiment of the present disclosure;

[0015] FIG. 3 is a schematic view showing a micro cavity according to one embodiment of the present disclosure;

[0016] FIG. 4 is a flow chart of a method for manufacturing the OLED display element according to one embodiment of the present disclosure;

[0017] FIG. 5 is a flow chart of another method for manufacturing the OLED display element according to one embodiment of the present disclosure; and

[0018] FIG. 6 is a flow chart of yet another method for manufacturing the OLED display element according to one embodiment of the present disclosure.

REFERENCE SIGN LIST

[0019]	11 base substrate
[0020]	12 ITO layer
[0021]	13 metal oxide conductor layer
[0022]	14 cathode
[0023]	15 micro cavity
[0024]	16 auxiliary metal layer
[0025]	21 gate electrode
[0026]	22 gate insulation layer
[0027]	23 source electrode
[0028]	24 drain electrode
[0029]	25 active layer
[0030]	151 hole injection layer
[0031]	152 hole transport layer
[0032]	153 organic light-emitting layer
[0033]	154 electron injection layer
[0034]	155 electron transport layer

DETAILED DESCRIPTION OF THE EMBODIMENTS

[0035] It will describe an OLED display element, its manufacturing method and a display device hereinafter in conjunction with the drawings and embodiments.

[0036] Unless otherwise defined, any technical or scientific term used herein shall have the common meaning understood by a person of ordinary skills. Such words as “first” and “second” used in the specification and claims are merely used to differentiate different components rather than to represent any order, number or importance. Similarly, such words as “one” or “one of” are merely used to represent the existence of at least one member, rather than to limit the number thereof. Such words as “connect” or “connected to” may include electrical connection, direct or indirect, rather than to be limited to physical or mechanical connection. Such words as “on”, “under”, “left” and “right” are merely used to represent relative position relationship, and when an absolute position of the object is changed, the relative position relationship will be changed too.

[0037] Referring to FIG. 1 or 2, the present disclosure provides in some embodiments an OLED display element, which includes a light-emitting pixel unit. The light-emitting pixel unit includes an anode arranged above a base substrate 11, a cathode 14 arranged opposite to the anode, and a micro cavity 15 formed between the anode and the cathode 14. The micro cavity 15 includes an organic light-emitting layer, and the anode includes an ITO layer 12 arranged opposite to the cathode 14 and a metal oxide conductor layer 13 arranged at a side of the ITO layer 12 that is farther away from the cathode 14 than the other side of the ITO layer 12.

[0038] According to the OLED display element in the embodiments of the present disclosure, the anode of the light-emitting pixel unit includes the ITO layer 12 and the metal oxide conductor layer 13. In the case that a voltage is

applied to the OLED display element, holes in the ITO layer 12 and the metal oxide conductor layer 13 and electrons in the cathode 14 are transported to the organic light-emitting layer. The holes and the electrons meet in the organic light-emitting layer, so as to excite the organic light-emitting layer to generate photons in various energy states, thereby to generate light beams. The photons in various energy states are reallocated in the micro cavity between the anode and the cathode 14, so that a light beam having a wavelength in conformity with a resonant cavity mode may be transmitted to an exterior of the OLED display element, thereby the OLED display element starts to emit light. As compared with the prior art where merely the ITO layer 12 is used as the anode of the light-emitting pixel unit, in the embodiments of the present disclosure, the ITO layer 12 and the metal oxide conductor layer 13 are used as the anode of the light-emitting pixel unit. A cavity length of the micro cavity 15 between the anode and the cathode 14 (i.e. a distance between a surface of the cathode 14 facing the micro cavity 15 and a surface of the anode facing the micro cavity 15) may be adjusted, so as to improve a micro cavity effect of the OLED display element. In addition, due to the fact that the anode is formed by the ITO layer 12 and the metal oxide conductor layer 13, it is able to improve a work function of the anode and increase the luminous intensity of a light beam transmitted from the organic light emitting layer and having a specific wavelength, thereby to improve the luminous intensity and the luminous efficiency of the OLED display element. Further, due to the fact that the micro cavity 15 is formed between the cathode 14 and the anode formed by the ITO layer 12 and the metal oxide conductor layer 13, it is able to narrow an FWHM of the light beam from the OLED display element, i.e., to acquire a narrowed spectrum, and prevent the light beams in different colors from interfering with each other, thereby to improve color purity of the OLED display element.

[0039] It should be appreciated that, the cathode may be made of a metal or a metal oxide. Usually, in the case that a bottom-emission OLED display element is to be manufactured, the cathode may be made of a metal having high reflectivity or a metal oxide having reflectivity higher than the anode, so as to enable the light beams from the OLED display element to be transmitted through the anode. In the case that a top-emission OLED display element is to be manufactured, the cathode may be made of a transparent or semi-transparent metal oxide, and the reflectivity of the anode may be increased, so as to enable the light beams from the OLED display element to be transmitted through the cathode.

[0040] In the case of manufacturing a color display device including the OLED display element, a plurality of light-emitting pixel units is arranged on the base substrate 11, and each light-emitting pixel unit includes at least one red (R) pixel unit, at least one blue (B) pixel unit and at least one green (G) pixel unit. The micro cavities for the R, G and B pixel units have different cavity lengths. In order to improve the color purity of the light beam from the OLED display element, the anodes of the R, G and B pixel units may include, or not include, the metal oxide conductor layer 13 according to the practical need.

[0041] Referring again to FIG. 1 or 2, in the embodiments of the present disclosure, the OLED display element further includes a thin film transistor (TFT) arranged on the base substrate 11. The TFT includes a gate electrode 21 arranged

on the base substrate **11**, a gate insulation layer **22** covering the base substrate **11** and the gate electrode **21**, and a source electrode **23**, a drain electrode **24** and an active layer **25** arranged above the gate insulation layer **22**. The source electrode **23** and the drain electrode **24** are arranged at an identical layer and separated from each other, and the drain electrode **24** is connected to the anode. The metal oxide conductor layer **13** of the anode of the light-emitting pixel unit is arranged between the ITO layer **12** of the anode and the gate insulation layer **22**. The TFT, as a switch for the light-emitting pixel unit, is configured to control the light-emitting pixel unit to emit light.

[0042] In the embodiments of the present disclosure, the active layer **25** and the metal oxide conductor layer **13** may be each made of a metal oxide. The metal oxide forming the active layer **25** may be identical to, or different from, the metal oxide forming the metal oxide conductor layer **13**. In order to reduce process steps for forming the OLED display element, preferably, as shown in FIG. 1 or 2, the metal oxide conductor layer **13** of the light-emitting pixel unit is arranged at a layer identical to the active layer **25** of the TFT. The metal oxide conductor layer **13** may be formed by subjecting to the metal oxide deposited in the light-emitting pixel unit to ion surface treatment. In this way, it is able to form the metal oxide conductor layer **13** and the active layer **25** through a single patterning process, so as to reduce the process steps as well as the number of mask plates to be used, thereby to reduce the time for manufacturing the OLED display element as well as the production cost. A thickness of the metal oxide conductor layer **13** may be adjusted through a halftone mask plate, so as to adjust the cavity length of the micro cavity **15**. As a result, it is able to improve a micro cavity effect of the OLED display element and acquire a narrowed spectrum, thereby to improve the luminous intensity and the luminous efficiency of the OLED display element, and improve the color purity of the light beam from the OLED display element.

[0043] The active layer **25** and the metal oxide conductor layer **13** may be made of one of various materials, e.g., indium gallium zinc oxide (IGZO), indium zinc oxide (IZO) or zinc oxide (ZnO). It should be appreciated that, after patterns of the active layer **25** and the metal oxide conductor layer **13** are formed above the base substrate **11**, a surface of the metal oxide conductor layer **13** may be subjected to ion surface treatment, so as to improve the conductivity of the metal oxide conductor layer **13**. The active layer **25** may be connected to, or separated from, the metal oxide conductor layer **13**.

[0044] Referring to FIG. 1 or 2, the anode of the light-emitting pixel unit may further include an auxiliary metal layer **16** arranged between the ITO layer **12** of the anode and the gate insulation layer **22**, the auxiliary metal layer **16** is arranged on the metal oxide conductor layer **13**, or the metal oxide conductor layer **13** is arranged on the auxiliary metal layer **16**. The auxiliary metal layer **16** may be arranged at the anode. A thickness of the auxiliary metal layer **16** may be adjusted so as to adjust a cavity length of the micro cavity **15**. As a result, it is able to improve the micro cavity effect of the OLED display element and acquire the narrowed spectrum, thereby to increase the luminous intensity and the luminous efficiency of the OLED display element and improve the color purity of the light beam from the OLED display element. In addition, through the auxiliary metal layer **16** arranged at the node, it is able to adjust a thickness

of the anode and thus adjust the cavity length of the micro cavity **16**, thereby to improve the micro cavity effect of the OLED display element. As a result, the OLED display element with good micro cavity effect may be implemented by adjusting the thickness of the auxiliary metal layer **16**. Further, in the case that the OLED display element is a top-emission OLED display element, through the auxiliary metal layer **16** arranged at the anode, it is able to increase the reflectivity of the anode, thereby to improve the luminous intensity and the luminous efficiency of the OLED display element.

[0045] The auxiliary metal layer **16** may be arranged separately, or arranged at a layer identical to the source electrode **23** and the drain electrode **24**. Optionally, referring again to FIG. 1 or 2, the auxiliary metal layer **16** is arranged at a layer, and made of a material, identical to the source electrode **23** and the drain electrode **24**. In this way, it is able to form the source electrode **23**, the drain electrode **24** and the auxiliary metal layer **16** through a single patterning process, so as to reduce the processing steps for forming the OLED display element and the number of the used mask plates, thereby to reduce the production time and the production cost. It should be appreciated that, the auxiliary metal layer **16** may be connected to, or separated from, the drain electrode **24**. In the case that the auxiliary metal layer **16** is connected to the drain electrode **24**, the anode of the light-emitting pixel unit is connected to the drain electrode **24**. At this time, the ITO layer **12** of the anode may be connected to the drain electrode **24** not through a via-hole above the drain electrode **24**, i.e., it is unnecessary to provide any via-hole above the drain electrode **24**. As a result, it is able to reduce the process steps for forming the OLED display element and the number of the used mask plates, thereby to reduce the time and the cost for producing the OLED display element.

[0046] For the light-emitting pixel unit of the LED display element, the metal oxide conductor layer **13** and the auxiliary metal layer **16** of the anode may be formed in an order in accordance with an order of a step of forming the active layer **25** and a step of forming the source electrode **23** and the drain electrode **24** of the TFT. During the implementation, there exist the following two ways for forming the metal oxide conductor layer **13** and the auxiliary metal layer **16** of the anode.

[0047] In one way, referring to FIG. 1, in the TFT, the source electrode **23** and the drain electrode **24** are arranged on the gate insulation layer **22**, and the active layer **25** is arranged on the source electrode **23**, the drain electrode **24** and a channel between the source electrode **23** and the drain electrode **24**. In the light-emitting pixel unit, the auxiliary metal layer **16** is arranged on the gate insulation layer **22**, and the metal oxide conductor layer **13** is arranged on the auxiliary metal layer **16**. In this way, it is able to prevent the active layer **25** from being in contact with an etchant in the case that the patterns of the source electrode **23** and the drain electrode **24** are formed on the active layer **25**, thereby to prevent the active layer **25** from being etched by the etchant and prevent the characteristics of the TFT from being adversely affected.

[0048] In another way, referring to FIG. 2, in the TFT, the active layer **25** is arranged on the gate insulation layer **22**, and the source electrode **23** and the drain electrode **24** are arranged on the active layer **25**. In the light-emitting pixel unit, the metal oxide conductor layer **13** is arranged on the

gate insulation layer **22**, and the auxiliary metal layer **16** is arranged on the metal oxide conductor layer **13**. It is not necessary to arrange an oxide insulation layer between the drain electrode **24** and the ITO layer **12** of the anode, so one end of the ITO layer **12** of the anode may be directly formed on the drain electrode **24**, so that the ITO layer **12** of the anode is directly connected to the drain electrode **24**. As a result, it is not necessary to form above the drain electrode **24** the via-hole through which the ITO layer **12** may be connected to the drain electrode **24**, so as to reduce the process steps for manufacturing the OLED display element and the number of the used mask plates, thereby to reduce the time and the cost for manufacturing the OLED display device.

[0049] In the embodiments of the present disclosure, in order to adjust the cavity length of the micro cavity **15** of the light-emitting pixel unit conveniently, referring to FIG. **3**, the micro cavity **15** further includes a hole injection layer **151** and a hole transport layer **152** arranged between the hole injection layer **151** and an organic light-emitting layer **153**, and an electron injection layer **155** and an electron transport layer **154** arranged between the cathode **14** and the organic light-emitting layer **153**. The hole transport layer **152** is arranged between the organic light-emitting layer **153** and the hole injection layer **151**, and the electron transport layer **154** is arranged between the organic light-emitting layer **153** and the electron injection layer **155**. In this way, it is able to adjust the cavity length of the micro cavity **15** by adjusting thicknesses of the hole injection layer **151**, the hole transport layer **152**, the electron injection layer **155**, the electron transport layer **154** and/or the organic light-emitting layer **153**. As a result, it is able to improve the micro cavity effect of the OLED display element and acquire the narrowed spectrum, thereby to increase the luminous intensity and the luminous efficiency of the OLED display element and improve the color purity of the light beam from the OLED display element.

[0050] The present disclosure further provides in some embodiments a display device including the above-mentioned OLED display element.

[0051] The advantages of the display device are identical to those of the above-mentioned OLED display element, and thus will not be particularly defined herein.

[0052] The display device may be any product or member having a display function, such as an electronic paper, a mobile phone, a flat-panel computer, a television, a laptop computer, a digital photo frame or a navigator.

[0053] Referring to FIG. **4**, the present disclosure further provides in some embodiments a method for manufacturing the above-mentioned OLED display element. The method includes: Step **101** of providing the base substrate; and Step **102** of forming the anode, the micro cavity and the cathode sequentially above the base substrate. The micro cavity includes the organic light-emitting layer. The anode includes the ITO layer arranged opposite to the cathode, and the metal oxide conductor layer arranged between the ITO layer and the base substrate.

[0054] The advantages of the method are identical to those of the above-mentioned OLED display element, and thus will not be particularly defined herein.

[0055] In the embodiments of the present disclosure, prior to the step of forming the anode, the micro cavity and the cathode sequentially above the base substrate, the method further includes forming the gate electrode and the gate

insulation layer on the base substrate, and forming the active layer, the source electrode and the drain electrode above the gate insulation layer. The source electrode and the drain electrode may be arranged at an identical layer and separated from each other. The drain electrode is connected to the anode. The metal oxide conductor layer of the anode is arranged between the ITO layer of the anode and the gate insulation layer.

[0056] In the embodiments of the present disclosure, the metal oxide conductor layer of the light-emitting pixel unit is arranged at a layer identical to the active layer of the TFT. The metal oxide conductor layer may be formed by subjecting the metal oxide deposited in the light-emitting pixel unit to ion surface treatment.

[0057] In the embodiments of the present disclosure, the anode of the light-emitting pixel unit further includes the auxiliary metal layer arranged between the ITO layer of the anode. The auxiliary metal layer is arranged on the metal oxide conductor layer, or the metal oxide conductor layer is arranged on the auxiliary metal layer. The auxiliary metal layer may be arranged at a layer identical to the source electrode and the drain electrode.

[0058] In the embodiments of the present disclosure, in the TFT, the source electrode and the drain electrode are arranged on the gate insulation layer, and the active layer is arranged on the source electrode, the drain electrode, and the channel between the source electrode and the drain electrode. In the light-emitting pixel unit, the auxiliary metal layer is arranged on the gate insulation layer, and the metal oxide conductor layer is arranged on the auxiliary metal layer.

[0059] Alternatively, in the TFT, the active layer is arranged on the gate insulation layer, and the source electrode and the drain electrode are arranged on the active layer. In the light-emitting pixel unit, the metal oxide conductor layer is arranged on the gate insulation layer, and the auxiliary metal layer is arranged on the metal oxide conductor layer.

[0060] During the implementation, referring to FIG. **5**, the active layer of the TFT is arranged on the source electrode, the drain electrode and the channel between the source electrode and the drain electrode. In the case that the metal oxide conductor layer of the light-emitting pixel unit is arranged on the auxiliary metal layer, the method includes: Step **101** of providing the base substrate; Step **201** of forming the gate electrode and the gate insulation layer on the base substrate; Step **202** of forming the source electrode, the drain electrode and the auxiliary metal layer on the gate insulation layer; Step **203** of forming the active layer on the source electrode, the drain electrode, and the channel between the source electrode and the drain electrode, and forming the metal oxide conductor layer on the auxiliary metal layer; and Step **102** of forming the ITO layer, the micro cavity and the cathode sequentially above the active layer and on the metal oxide conductor layer.

[0061] Referring to FIG. **6**, in the case that the source electrode and the drain electrode of the TFT are arranged on the active layer, and the auxiliary metal layer of the light-emitting pixel unit is arranged on the metal oxide conductor layer, the method includes: Step **101** of providing the base substrate; Step **201** of forming the gate electrode and the gate insulation layer on the base substrate; Step **202** of forming the active layer and the metal oxide conductor layer on the gate insulation layer; Step **203** of forming the source

electrode and the drain electrode on the active layer, and forming the auxiliary metal layer on the metal oxide conductor layer; and Step 102 of forming the ITO layer, the micro cavity and the cathode sequentially above the source electrode and the drain electrode and on the auxiliary metal layer.

[0062] The above features, structures, materials and features may be combined in any appropriate manner in one or more embodiments.

[0063] The above are merely the preferred embodiments of the present disclosure, but the present disclosure is not limited thereto. Obviously, a person skilled in the art may make further modifications and improvements without departing from the spirit of the present disclosure, and these modifications and improvements shall also fall within the scope of the present disclosure.

1. An organic light-emitting diode (OLED) display element, comprising a light-emitting pixel unit, wherein the light-emitting pixel unit comprises an anode arranged above a base substrate, a cathode arranged opposite to the anode, and a micro cavity formed between the anode and the cathode, the micro cavity comprises an organic light-emitting layer, and the anode comprises an indium tin oxide (ITO) layer and a metal oxide conductor layer, wherein the ITO layer is arranged opposite to the cathode, and the metal oxide conductor layer is arranged at a side of the ITO layer that is farther away from the cathode than the other side of the ITO layer.
2. The OLED display element according to claim 1, further comprising a thin film transistor (TFT) arranged on the base substrate, wherein the TFT comprises:
 - a gate electrode arranged on the base substrate;
 - a gate insulation layer covering the base substrate and the gate electrode; and
 - an active layer, a source electrode and a drain electrode arranged above the gate insulation layer,
 wherein the source electrode and the drain electrode are arranged at an identical layer and separated from each other, and the drain electrode is connected to the anode; and the metal oxide conductor layer of the anode is arranged between the ITO layer of the anode and the gate insulation layer.
3. The OLED display element according to claim 2, wherein the metal oxide conductor layer of the light-emitting pixel unit and the active layer of the TFT are arranged at an identical layer.
4. The OLED display element according to claim 2, wherein the metal oxide conductor layer is formed by subjecting metal oxide deposited in the light-emitting pixel unit to ion surface treatment.
5. The OLED display element according to claim 2, wherein the anode of the light-emitting pixel unit further comprises an auxiliary metal layer arranged between the ITO layer of the anode and the gate insulation layer; and the auxiliary metal layer is arranged on the metal oxide conductor layer, or the metal oxide conductor layer is arranged on the auxiliary metal layer.

6. The OLED display element according to claim 5, wherein the auxiliary metal layer, the source electrode and the drain electrode are arranged at an identical layer.

7. The OLED display element according to claim 5, wherein the auxiliary metal layer, the source electrode and the drain electrode are made of an identical material.

8. The OLED display element according to claim 5, wherein the auxiliary metal layer is connected to the drain electrode.

9. The OLED display element according to claim 6, wherein

in the TFT, the source electrode and the drain electrode are arranged on the gate insulation layer, and the active layer is arranged on the source electrode, the drain electrode and a channel between the source electrode and the drain electrode; and

in the light-emitting pixel unit, the auxiliary metal layer is arranged on the gate insulation layer, and the metal oxide conductor layer is arranged on the auxiliary metal layer.

10. The OLED display element according to claim 6, wherein

in the TFT, the active layer is arranged on the gate insulation layer, and the source electrode and the drain electrode are arranged on the active layer; and

in the light-emitting pixel unit, the metal oxide conductor layer is arranged on the gate insulation layer, and the auxiliary metal layer is arranged on the metal oxide conductor layer.

11. The OLED display element according to claim 1, wherein the micro cavity further comprises:

a hole injection layer and a hole transport layer arranged between the ITO layer of the anode and the organic light-emitting layer, the hole transport layer being arranged between the organic light-emitting layer and the hole injection layer; and

an electron injection layer and an electron transport layer arranged between the cathode and the organic light-emitting layer, the electron transport layer being arranged between the organic light-emitting layer and the electron injection layer.

12. A display device, comprising the OLED display element according to claim 1.

13. A method for manufacturing the OLED display element according to claim 1, comprising:

providing the base substrate; and forming the anode, the micro cavity and the cathode sequentially above the base substrate,

wherein the micro cavity comprises an organic light-emitting layer, and

the anode includes the ITO layer and the metal oxide conductor layer, wherein the ITO layer is arranged opposite to the cathode, and the metal oxide conductor layer is arranged between the ITO layer and the base substrate.

14. The method according to claim 13, wherein prior to the step of forming the anode, the micro cavity and the cathode sequentially above the base substrate, the method further comprises:

forming a gate electrode and a gate insulation layer on the base substrate; and

forming an active layer, a source electrode and a drain electrode above the gate insulation layer,

wherein the source electrode and the drain electrode are arranged at an identical layer and separated from each other, and the drain electrode is connected to the anode, and

the metal oxide conductor layer of the anode is arranged between the ITO layer of the anode and the gate insulation layer.

15. The method according to claim **14**, wherein the metal oxide conductor layer of the light-emitting pixel unit and the active layer of the TFT are arranged at an identical layer.

16. The method according to claim **14**, wherein the metal oxide conductor layer is formed by subjecting metal oxide deposited in the light-emitting pixel unit to ion surface treatment.

17. The method according to claim **14**, wherein the anode of the light-emitting pixel unit further comprises an auxiliary metal layer arranged between the ITO layer of the anode and the gate insulation layer; the auxiliary metal layer is arranged on the metal oxide conductor layer, or the metal oxide conductor layer is arranged on the auxiliary metal layer; and the auxiliary metal layer, the source electrode and the drain electrode are arranged at an identical layer.

18. The method according to claim **17**, wherein in the TFT, the source electrode and the drain electrode are arranged on the gate insulation layer, and the active layer is arranged on the source electrode, the drain electrode, and a channel between the source electrode and the drain electrode; in the light-emitting pixel unit, the auxiliary metal layer is arranged on the gate insulation layer, and the metal oxide conductor layer is arranged on the auxiliary metal layer; or

in the TFT, the active layer is arranged on the gate insulation layer, and the source electrode and the drain electrode are arranged on the active layer; in the light-emitting pixel unit, the metal oxide conductor layer is arranged on the gate insulation layer, and the auxiliary metal layer is arranged on the metal oxide conductor layer.

19. The OLED display element according to claim **2**, wherein the micro cavity further comprises:

a hole injection layer and a hole transport layer arranged between the ITO layer of the anode and the organic light-emitting layer, the hole transport layer being arranged between the organic light-emitting layer and the hole injection layer; and

an electron injection layer and an electron transport layer arranged between the cathode and the organic light-emitting layer, the electron transport layer being arranged between the organic light-emitting layer and the electron injection layer.

20. The OLED display element according to claim **3**, wherein the micro cavity further comprises:

a hole injection layer and a hole transport layer arranged between the ITO layer of the anode and the organic light-emitting layer, the hole transport layer being arranged between the organic light-emitting layer and the hole injection layer; and

an electron injection layer and an electron transport layer arranged between the cathode and the organic light-emitting layer, the electron transport layer being arranged between the organic light-emitting layer and the electron injection layer.

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摘要(译)

提供一种OLED显示元件，其制造方法和显示装置。OLED显示元件包括发光像素单元。发光单元包括布置在基础基板上的阳极，与阳极相对布置的阴极，以及形成在阳极和阴极之间的微腔。微腔包括有机发光层，阳极包括与阴极相对设置的ITO层和设置在ITO层一侧的金属氧化物导体层，该ITO层比阴极的另一侧更远离阴极。ITO层。

